



# Data Sheet

Customer:	
Part No:	CL-SF685DNBUSD-02
Sample No:	
Description:	3528 Blue/Red SMD
Item No:	

Customer			
Check	Inspection	Approval	Date





### **Features**

■ Package Size:  $3.5(L) \times 2.8(W) \times 1.9(T)$ mm

■ Silicone Packed

■ Suitable for different working environment

■ Super long lifetime: 50000HRs

■ Anti UV

■ White colors are available in(2300K- 25000K)

■ Wide viewing angle  $(2^{\theta}1/2 = 120^{\circ})$ 

## **Applications**

■ Indoor lighting: Fluorescent lamp, tube

 Commercial illumination and displays: Advertising words, light box

LCD Backlighting

■ Decorative lighting: light strip

Automotive interior auxiliary lighting

Other illumination and displays

### **Device Selection Guide**

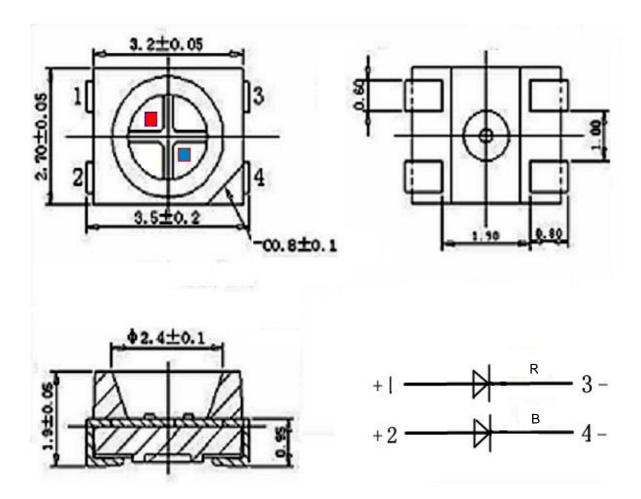
ITEM	MATERIALS
Resin	Silicon
Bonding wire	25 Em Au
Lens color	Water Clear
Dice	InGaN





### REFLECTOR COATING TYPE HIGH-PERFORMANCE LEDS

### High Performance SMD Single-Color Top LEDs



### NOTES:

- 1. All dimensions are in millimeters (inches):
- 2. Tolerances are 0.2mm (0.008inch) unless otherwise noted





# Absolute maximum ratings

(TA=25℃)

Paramete	Symbol	Rat	Unit
Forward current	I F	20	mA
Reverse voltage	VR	5	V
Power dissipation	Pd	0.12	W
Operating Temperature	ТОР	-20 ~+80	$^{\circ}$
Storage Temperature	Tstg	-40 ~+80	${\mathbb C}$
Peak Forward Current ( Duty 1/10 @ 1KHz)	lFP	20	mA
Lead Soldering Temperature (5mm From Body)	TSOI	260°C For 5 Seconds)/°C	

# **Electro-optical characteristics**

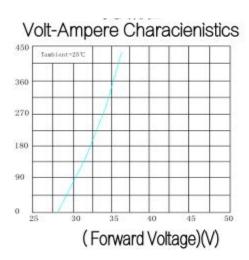
 $(TA=25^{\circ}C)$ 

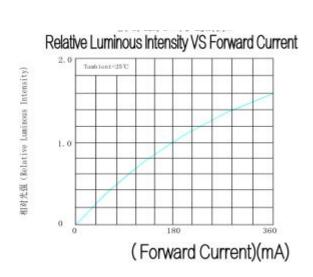
Parameter	T4 C 1:4:	Symbo	Value			Unit
	Test Condition	S J 1112 0	Min	Avg	Avg Max	
Forward voltage	I F =20mA	Vf	1.9		3.4	V
Dominant wavelength	I F = 20mA R	nm	630	632	635	nm
	I F = 20mA B	nm	460	462	465	nm
<b>Luminous intensity</b>	IF=20mA R	mcd	400	500	600	mcd
	I F = 20mA B	mcd	200	300	400	mcd
Viewing Angle	////////	201/2	///////	120	///////	deg
Reverse Current	/////////	IR	///////	/////	10	EA

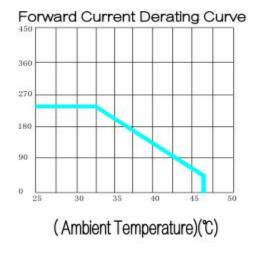


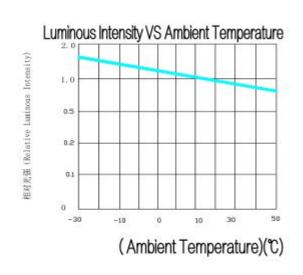


### (Optical-Electrical Characteristic)













### **Reliability Test Items And Conditions**

TestItems	Reference	Test Conditions	Time	Quantity	Criterion
Thermal Shock	MIL-STD-202G	-40°C (30min) -100°C (30min)	100Cycles	22	0/22
Temperature	JEITA ED-4701 200 203	-10℃~65℃; 0%~90%RH	10cycles	22	0/22
High temperature storage	JEITA ED -4071 200 201	Ta=100℃	1000H	22	0/22
Low temperature storage	e JEITA ED -4071 200 202	Ta=-40°C	1000Н	22	0/22
High temperature high humidity st		Ta=60℃; RH=90%	1000H	22	0/22
High temperature	e JESD22-A108D	Ta=80°C	1000H	22	0/22
Normal temperatu	re JESD22-A108D	Ta=25℃ IF=150mA	1000H	22	0/22
Resistance to soldering heatt	GB/T 4937, II , 2.2&2.3	Tsol*=(240±5)℃ 10secs	2 times	22	0/22

### Criteria For Judging Damage

TestItems	Symbol	Test Condition	s Criteria For Judging Damage
ForwardVoltage	VF	I F =I FT	Initial Data±10%
RecerseCurrent	IR	V R =5V	IR ≤10uA
LuminousIntensity	IV	I F =I FT	Average I V attenuation ≤ 30%; single I V attenuation ≤ 50%
Resistance to soldering heat			No cracks inside the material, no material bursting, peeling, no death light

<sup>\*</sup>Note Tsol-Temperature of tin liquid





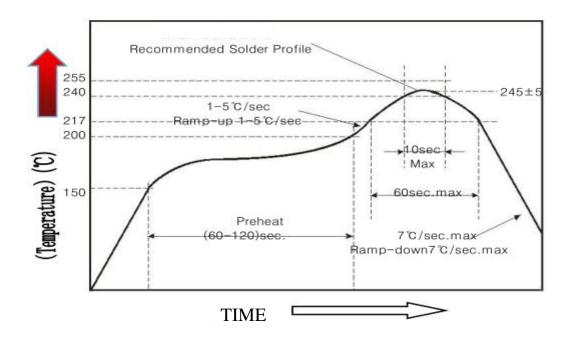
### (Useful hint):

#### 1, Hand Soldering

A soldering iron of less than 20W is recommended to be used in Hand Soldering. Please keep the temperature fo the soldering iron under  $360\,^{\circ}$ C while soldering. Each terminal fo the LED is to go for less than 3 second and for one time only.

Be careful because the damage of the product is often started at the time of the hand soldering.

2Reflow Soldering: Use the conditions shown in the under Figure of Pb-Free Reflow Soldering



- Reflow soldering only allowed to do once
- Stress on the LEDs should be avoided during heating in soldering process
- After soldering, do not deal with the product before its temperature drop down to room Temperature.





### Precautions(1)

- 1. Storage
- Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to aminimum.
- Before opening the package, the product should be kept at 30°C or less and humidity less than 60% RH, and beused within a year.
- After opening the package, the product should be stored at 30°C or less and humidity less than 10%RH, and besoldered within 24 hours (1day). It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.
- If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition:  $(70\pm5)^{\circ}$  for 24 hours

#### 2. Static Electricity

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.





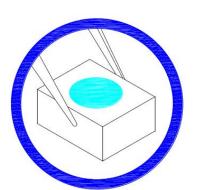
### **Precautions (2)**

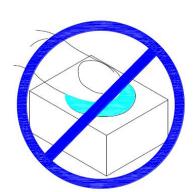
#### 3. Vulcanization

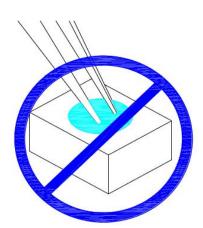
LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag2S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperatre drift and serious decline, seriously affecting the performance of the product. So we should take corresponding measures to avioding vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.

### **Handling Precautions**

1. Handle the component along the side surface by using forceps or appropriate tools; do not directly touch or Handle the silicone lens surface, it may damage the internal circuitry.







- 2. Do not stack together assembled PCBs containing LEDs. PH<7
  - Impact may scratch the silicone lens or damage the internal circuitry
- 3. Not suitable to operate in acidic envi-ronment,

